



MMBD4448W

SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 1, 2 and 3)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

SOT-323



Top View



Top View Internal Schematic

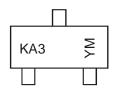
Ordering Information (Notes 3 & 4)

Part Number	Case	Packaging
MMBD4448W-7-F	SOT-323	3000/Tape & Reel

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. Product manufactured with Green Molding Compound and does not contain Halogens or Sb₂O₃ Fire Retardants.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



KA3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Key

Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	N	Р	R	S	Т	U	V	W	Х	Υ	Z	Α	В	С
		1												
Month	Jan	Feb	Mai		Apr	May	Jun	Jul	Aug	Se	p C	Oct	Nov	Dec



Characteristic		Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V	
RMS Reverse Voltage		V _{R(RMS)}	53	V	
Forward Continuous Current (Note 4)		I _{FM}	500	mA	
Average Rectified Output Current (Note 4)		lo	250	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 1.0	А	

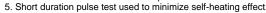
Thermal Characteristics

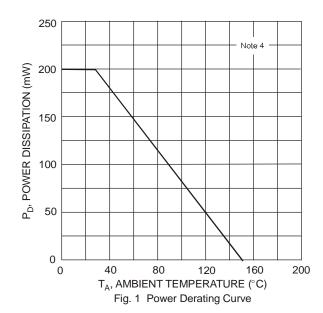
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-65 to +150	°C

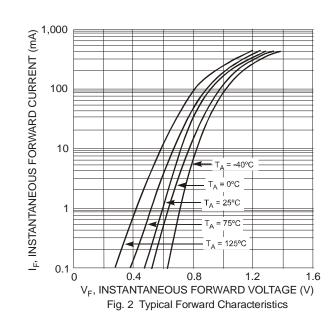
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	75	_	V	$I_R = 10\mu A$
		0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage	VF	_	0.855		$I_F = 10mA$
l olward voltage	٧F	_	1.0		$I_F = 100 \text{mA}$
		_	1.25		I _F = 150mA
			1.0	μА	V _R = 75V
Reverse Current (Note 5)			50	μA	$V_R = 75V, T_J = 150$ °C
Reverse Current (Note 5)	I _R	IR —	30	μΑ	$V_R = 25V, T_J = 150^{\circ}C$
			25	nA	$V_R = 20V$
Total Capacitance	C _T	_	2.0	pF	$V_R = 0, f = 1.0MHz$
Poverce Peccyany Time			4.0		$I_F = I_R = 10 \text{mA},$
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100\Omega$

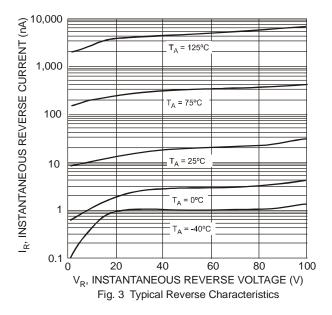
Notes: 4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com.
5. Short duration pulse test used to minimize self-heating effect.

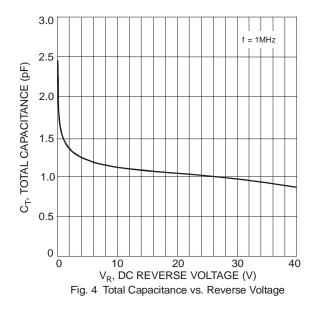




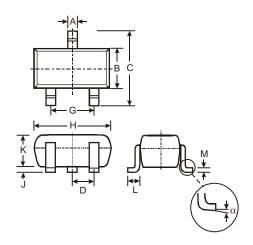






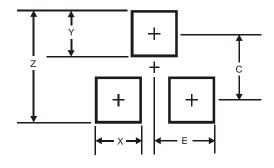


Package Outline Dimensions



Dim Min A 0.25 B 1.15 C 2.00 D - G 1.20 H 1.80 J 0.0 K 0.90	Max 0.40 1.35 2.20 - 1.40	7yp 0.30 1.30 2.10 0.65			
B 1.15 C 2.00 D - G 1.20 H 1.80 J 0.0	1.35 2.20	1.30 2.10 0.65			
C 2.00 D - G 1.20 H 1.80 J 0.0	2.20	2.10 0.65			
D - G 1.20 H 1.80 J 0.0	-	0.65			
G 1.20 H 1.80 J 0.0	1.40				
H 1.80 J 0.0	1.40	,			
J 0.0		1.30			
	2.20	2.15			
K 0.00	0.10	0.05			
K 0.90	1.00	1.00			
L 0.25	0.40	0.30			
M 0.10	0.18	0.11			
α 0°	8°	-			
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0



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